| <b>PC</b><br>SOCIATION CONNECTING<br>COPyright 2005. IPC, Bannockburn, Illinois. All rights reserved under both<br>international and Pan-American copyright conventions. |  |                                  |   | This document is a declaration of the substances within the manufacturer listed item. Note: if the item is an assembly with lower level parts, the declaration encompasses all lower level materials for which the manufacturer has engineering responsibility. |                         |             |                                      |                                 |                                 |                         |                   |           |  |
|--|--|----------------------------------|---|---|-------------------------|-------------|--------------------------------------|---------------------------------|---------------------------------|-------------------------|-------------------|-----------|--|
|  | IPC Web Site for Information on IPC 1752 Standard Form 7 |                                  |   | * Declaration Class *<br>Class 6 - RoHS Yes/No, Homogeneous Materia   |                         |             |                                      |                                 | ials and M                      | als and Mfg Information |                   |           |  |
| Supplier Information   |  |                                  |   |   |                         |             |                                      |                                 |                                 |                         |                   |           |  |
| Company name*  | Company un   | mpany unique ID                  |   |   | Unique ID Authority     |             |                                      |                                 |                                 | Response Date*          |                   |           |  |
| nsemi  |  |                                  |   |   |                         |             |                                      |                                 | 2025-07-03                      |                         |                   |           |  |
| Contact Name   | tact Name Title - Contact                                |                                  |   | ]   | Phone - Contact*        |             |                                      |                                 | Email - Contact*                |                         |                   |           |  |
| Product-Env-Stewards Product Enviro Compliance   |  |                                  |   | NA  |                         |             |                                      | Product-Env-Stewards@onsemi.com |                                 |                         |                   |           |  |
| Authorized Representative* Title - Representative  |  |                                  |   | ]   | Phone - Representative* |             |                                      |                                 | Email - Representative*         |                         |                   |           |  |
| Product-Env-Stewards   | Product Envi   | Product Enviro Compliance        |   |   | NA                      |             |                                      |                                 | Product-Env-Stewards@onsemi.com |                         |                   |           |  |
| Requester Item Number  | Mfr Item Number  | Mfr Item Name                    |   | ·   | Effective Date          | Version     | N                                    | Manufacturing Site              |                                 | Weight*                 | UOM               | Unit Type |  |
|  | MC74VHC1G07DFT2<br>G-Q                                   | HC1G07DFT2 LOG CMOS GATE OPEN DI |   | N   | 2025-07-03              |             | С                                    | CN1                             |                                 | 5.2                     | mg                | Each      |  |
| Manufacturing Proccess Information   |  |                                  |   |   |                         |             |                                      |                                 |                                 |                         |                   |           |  |
| Terminal Plating / Grid Array Materia  | 1 Terminal Base  | Terminal Base Alloy J-           |   | Rating  | Peak Proc               | ess Body Te | ss Body Temperature Max Time at Peak |                                 | Temperat                        | ure Num                 | ber of Reflow Cyc | les       |  |
| Matte Tin (Sn) - annealed CU Alloy   |  |                                  | 1 |   | 260                     |             | С                                    | 30                              | secon                           | ds 3                    |                   |           |  |
| Comments   |  |                                  |   |   |                         |             |                                      |                                 |                                 |                         |                   |           |  |
| level 1 - maximum time at peak temperature d   | uring soldering is 10-3                                  | 0 seconds                        |   |   |                         |             |                                      |                                 |                                 |                         |                   |           |  |
| For more information regarding material com  | position please refer to                                 | page 3                           |   |   |                         |             |                                      |                                 |                                 |                         |                   |           |  |

| RoHS Material Composition Declaration  |   |  |   | Declaration Type *                              | Detailed  |  |  |  |  |  |
|--|---|--|---|---|---|--|--|--|--|--|
| Directive 2015/863/EU amending RoHS<br>Directive 2011/65/EU  | RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl phthalate (BBP), Dibutyl phthalate (DBP), Diisobutyl phthalate (DIBP). |  |   |   |   |  |  |  |  |  |
| cadmium, hexavalentchromium, polybrominate<br>contains a RoHS restricted substance inexcess<br>encompass all such components. Supplier certif<br>as of the date that Supplier completes this form<br>Company acknowledges that Supplier may hav<br>independently verified information provided by<br>certification in this paragraph. If the Company a | ed biphenyls and/or polybrominated dip<br>of an applicable quantity limit, please ir<br>ies that it gathered the information it pro-<br>.Supplier acknowledges that Company<br>e relied on informationprovided by othe<br>y others, Supplier agrees that, at a minin<br>and the Supplier enter into a written agre<br>pource of the Supplier's liability and the  | henyl ethers (each a "<br>ndicate below which, i<br>ovides in this form us<br>will rely on this certifiers<br>in completing this<br>num, itssuppliers have<br>eement with respect to<br>Company's remedies | RoHS restricted substance") in exce<br>if any, RoHS exemption you believe<br>ing appropriate methods to ensure if<br>ication in determining the complian<br>form, and that Supplier may not have<br>e provided certifications regarding the<br>to the identified part, the terms and cc<br>for issues that arise regarding inform | ce of its products with European Union membe    | ove. If a homogeneous material within the part<br>er level components, the declaration shall<br>l correct to the best of its knowledge and belief,<br>r state laws that implement the RoHS Directive.<br>wever, in situations where Supplier has not<br>tions are at least as comprehensive as the<br>anty rights and/or remedies provided as part of |  |  |  |  |  |
| RoHS Declaration * 1 - Item(s)   | does not contain RoHS restricted substa   | ances per the definitio  | on above  | Supplier Acceptance                             | * Accepted  |  |  |  |  |  |
| Exemption: If the declared item does not con applicable exemptions.  | ntain RoHS restricted substances per  | the definition above   | except for defined RoHS exempti   | ons, then select the corresponding response i   | n the RoHS Declaration above and choose all   |  |  |  |  |  |
| Exemption List Version   | EL-2011/534/EU  |  |   |   |   |  |  |  |  |  |
| Declaration Signature  |   |  |   |   |   |  |  |  |  |  |
| Instructions: Complete all of the required fin<br>Requester) and click on Submit Form to have  | elds on all pages of this form. Select the form returned to the Requester   | he "Accepted" on th  | e Supplier Acceptance drop-down   | . This will display the signature area. Digital | lly sign the declaration (if required by the  |  |  |  |  |  |
| Supplier Digital Signature Ra  | stislav Drska   | Le   |   |   |   |  |  |  |  |  |

## Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

| Homogeneous Material | Weight | Unit of Measure | Level    | Substance  | CAS         | Exempt | Weight | Unit of Measure |
|----------------------|--------|-----------------|----------|--|-------------|--------|--------|-----------------|
| Die                  | 0.19   | mg              | Supplier | Silicon (Si)   | 7440-21-3   | Exempt | 0.19   | mg              |
| Lead Frame           | 2.04   | mg              | В        | Nickel (Ni)  | 7440-02-0   |        | 0.7813 | mg              |
|                      |        | -               | Supplier | Iron (Fe)  | 7439-89-6   |        | 1.0792 | mg              |
|                      |        |                 | Supplier | Copper (Cu)  | 7440-50-8   |        | 0.1795 | mg              |
| Mold Compound-Black  | 3.9    | mg              | Supplier | Boron zinc hydroxide oxide                             | 138265-88-0 |        | 0.117  | mg              |
|                      |        |                 | Supplier | Zinc Monoxide (ZnO)                                    | 1314-13-2   |        | 0.0195 | mg              |
|                      |        |                 | Supplier | 2,4,6-triamino-s-triazincompd.withs-<br>triazine-triol | 37640-57-6  |        | 0.117  | mg              |
|                      |        |                 | Supplier | Silica Amorphous (SiO2)                                | 7631-86-9   |        | 3.12   | mg              |
|                      |        |                 | Supplier | Carbon Black (C)                                       | 1333-86-4   |        | 0.039  | mg              |
|                      |        |                 | Supplier | Ortho-Cresol Novolac Resin                             | 29690-82-2  |        | 0.312  | mg              |
|                      |        |                 | Supplier | Phenolic Resin (Novolac)                               | 9003-35-4   |        | 0.1755 | mg              |
| Plating              | 0.05   | mg              | Supplier | Tin (Sn)   | 7440-31-5   |        | 0.05   | mg              |
| Wire Bond - Cu       | 0.02   | mg              | Supplier | Copper (Cu)  | 7440-50-8   |        | 0.02   | mg              |

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3 signa range of distribution unless otherwise noted).